

Silicon Carbide Power MOSFET N-Channel Enhancement Mode

Features

- · Optimized package with separate driver source pin
- Lower profile TO-247-4 package body
- High blocking voltage with low on-resistance
- High-speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q,,)
- · Halogen free, RoHS compliant

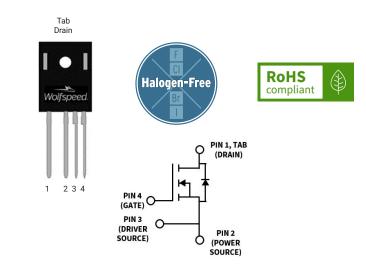
Benefits

- · Reduce switching losses and minimize gate ringing
- Higher system efficiency
- · Reduce cooling requirements
- Increase power density
- Increase system switching frequency

Applications

- Motor Control
- EV Battery Chargers
- High Voltage DC/DC Converters
- Solar/ESS
- UPS
- Enterprise PSU

Package



Part Number	Package	Marking		
C3M0016120K1	T0-247-4L LP	C3M0016120K1		

Key Parameters

Parameter	Symbol	Min.	Тур.	Max	Unit	Conditions	Note
Drain - Source Voltage	V _{DS}			1200		T _c = 25°C	
Maximum Gate - Source Voltage	V _{GS(max)}	-8		+19	v	Transient	
Operational Gate-Source Voltage	V _{GS op}		-4/15			Static	Note 1
	I _D			125	A	$V_{GS} = 15 \text{ V}, T_{C} = 25 \text{ °C}, T_{J} \le 175 \text{ °C}$	Fig. 19
DC Continuous Drain Current				90		$V_{GS} = 15 \text{ V}, T_{C} = 100 \text{ °C}, T_{J} \le 175 \text{ °C}$	Note 2
Pulsed Drain Current	I _{DM}			321		t_{Pmax} limited by T_{jmax} $V_{GS} = 15V$, $T_{C} = 25$ °C	Fig. 22
Power Dissipation	P _D			483	W	$T_{c} = 25 ^{\circ} \text{C}, T_{J} = 175 ^{\circ} \text{C}$	Fig. 20
Operating Junction and Storage Temperature	T_J , T_{stg}			-55 to +175	°C		
Solder Temperature	T _L			260		According to JEDEC J-STD-020	
Mounting Torque	M _D			1 8.8	Nm lbf-in	M3 or 6-32 screw	

Note (1): Recommended turn-on gate voltage is 15V with ±5% regulation tolerance, see Application Note PRD-04814 for additional details Note (2): Verified by design

Electrical Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions	Note	
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	1200			٧	V _{GS} = 0 V, I _D = 100 μA		
	Gate Threshold Voltage	1.8	2.5	3.8	٧	V _{DS} = V _{GS} , I _D = 22.08 mA	Fig. 11	
$V_{GS(th)}$			2.1		V	$V_{DS} = V_{GS}$, $I_D = 22.08$ mA, $T_J = 175$ °C		
I _{DSS}	Zero Gate Voltage Drain Current		1	50	μA	V _{DS} = 1200 V, V _{GS} = 0 V		
I _{GSS}	Gate-Source Leakage Current		10	250	nA	V _{GS} = 15 V, V _{DS} = 0 V		
R _{DS(on)}	Drain-Source On-State Resistance		16	22	mΩ	V _{GS} = 15 V, I _D = 80.28 A	Fig. 4,	
**DS(on)			29			$V_{GS} = 15 \text{ V, } I_D = 80.28 \text{ A, } T_J = 175^{\circ}\text{C}$	5, 6	
g_{fs}	Transconductance		54		S	V _{DS} = 20 V, I _{DS} = 80.28 A	Fig. 7	
gis	Transconductance		49		Ŭ	V _{DS} = 20 V, I _{DS} = 80.28 A, T _J = 175°C	rig. /	
C _{iss}	Input Capacitance		6922				Fig. 17, 18	
C_{oss}	Output Capacitance		231		pF	$V_{GS} = 0 \text{ V}, V_{DS} = 0 \text{V to } 1000 \text{ V}$		
C_{rss}	Reverse Transfer Capacitance		13			F = 100 kHz		
E _{oss}	C _{oss} Stored Energy		127		μJ	Vac = 25 mV	Fig. 16	
C _{o(er)}	Effective Output Capacitance (Energy Related)		268		pF	V _{GS} = 0 V, V _{DS} = 0 800V	Note: 3	
C _{o(tr)}	Effective Output Capacitance (Time Related)		404		pF			
E _{oN}	Turn-On Switching Energy (External Diode)		1287			V _{DS} = 800 V, V _{GS} = -4 V/15 V, I _D = 80.28 A,	Fig. 26, 28	
E _{OFF}	Turn Off Switching Energy (External Diode)		805		μJ	$R_{G(ext)}$ = 2.5 Ω, L= 59 μH, T_J = 175°C FWD = External SiC DIODE		
Eon	Turn-On Switching Energy (Body Diode FWD)		2552			V_{DS} = 800 V, V_{GS} = -4 V/15 V, I_{D} = 80.28 A,	Fig. 26, 28	
E _{OFF}	Turn-Off Switching Energy (Body Diode FWD)		788		μJ	$R_{G(ext)} = 2.5 \Omega$, L= 59 μ H, $T_J = 175$ °C FWD = Internal Body Diode		
$t_{\text{d(on)}}$	Turn-On Delay Time		19				Fig. 27, 28	
t_r	Rise Time		40			V_{DD} = 800 V, V_{GS} = -4 V/15 V I_D = 80.28 A, $R_{G(ext)}$ = 2.5 Ω ,		
$t_{\text{d(off)}}$	Turn-Off Delay Time		62		ns	Timing relative to V _{DS}		
t f	Fall Time		13		[inductive load		
R _{G(int)}	Internal Gate Resistance		2.6		Ω	f = 1 MHz, V _{AC} = 25 mV		
Q_{gs}	Gate to Source Charge		70			V _{DS} = 800 V, V _{GS} = -4 V/15 V		
Q_{gd}	Gate to Drain Charge		65	7	nC	I _D = 80.28 A	Fig. 12	
Qg	Total Gate Charge		223	7		Per IEC60747-8-4 pg 21		

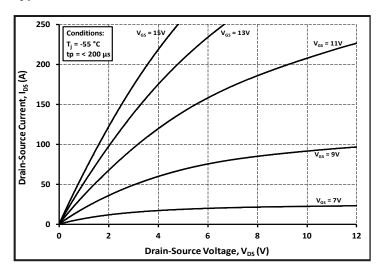
Note (3): $C_{O(er)}$, a lumped capacitance that gives same stored energy as Coss while Vds is rising from 0 to 500V $C_{O(tr)}$, a lumped capacitance that gives same charging time as Coss while Vds is rising from 0 to 500V

Reverse Diode Characteristics (T_c = 25°C unless otherwise specified)

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
V	Diode Forward Voltage	4.9		٧	V _{GS} = -4 V, I _{SD} = 40.14 A, T _J = 25 °C	Fig. 8, 9, 10
V _{SD}		4.4		٧	V _{GS} = -4 V, I _{SD} = 40.14 A, T _J = 175 °C	
Is	Continuous Diode Forward Current		88	А	V _{GS} = -4 V, T _C = 25°C	
I _{SM}	Diode pulse Current		321	А	V_{GS} = -4 V, pulse width t_p limited by T_{jmax}	
t _{rr}	Reverse Recover time	32		ns		
Q _{rr}	Reverse Recovery Charge	1665		nC	V _{GS} = -4 V, I _{SD} = 80.28 A, V _R = 800 V dif/dt = 5180 A/μs, Τ _ι = 175 °C	
I _{rrm}	Peak Reverse Recovery Current	82		Α	, J	
t _{rr}	Reverse Recover time	46		ns		
Q _{rr}	Q _{rr} Reverse Recovery Charge			nC	V _{GS} = -4 V, I _{SD} = 80.28 A, V _R = 800 V dif/dt = 2760 A/μs, Τ _ι = 175 °C	
l _{rrm}	Peak Reverse Recovery Current	45		А	α, α.ε. 2.700 / γ μος, ις	

Thermal Characteristics

Symbol	Parameter	Тур.	Unit	Test Conditions	Note
$R_{ heta JC}$	Thermal Resistance from Junction to Case	0.23	°C/W		Fig. 21



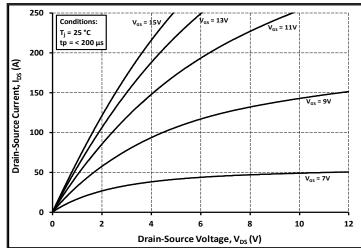
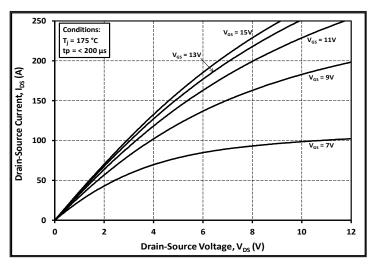


Figure 1. Output Characteristics T_J = -55 °C

Figure 2. Output Characteristics T_J = 25 °C



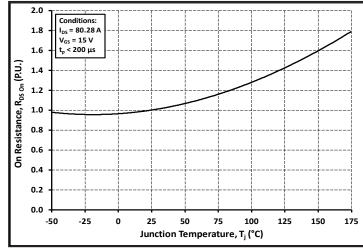
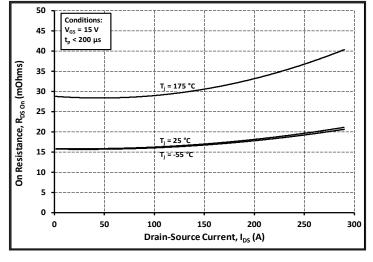


Figure 3. Output Characteristics T_J = 175 °C

Figure 4. Normalized On-Resistance vs. Temperature



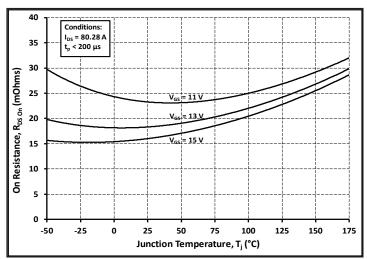


Figure 5. On-Resistance vs. Drain Current For Various Temperatures

Figure 6. On-Resistance vs. Temperature For Various Gate Voltage

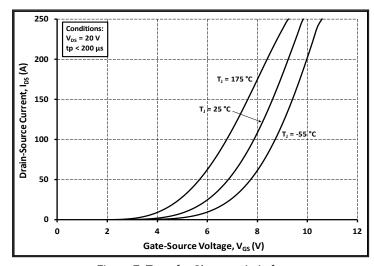


Figure 7. Transfer Characteristic for Various Junction Temperatures

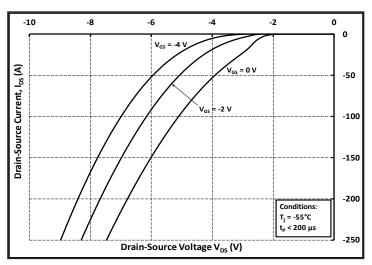


Figure 8. Body Diode Characteristic at -55 °C

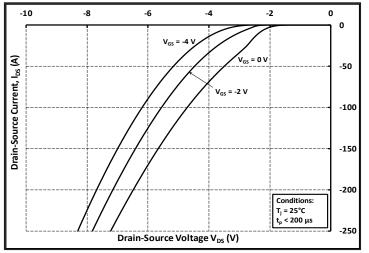


Figure 9. Body Diode Characteristic at 25 °C

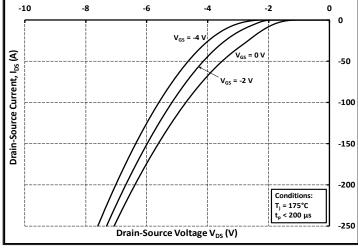


Figure 10. Body Diode Characteristic at 175 °C

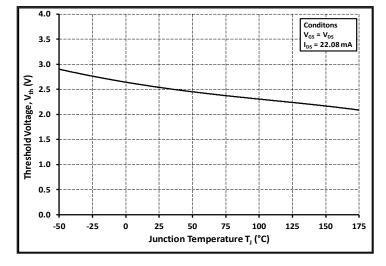


Figure 11. Threshold Voltage vs. Temperature

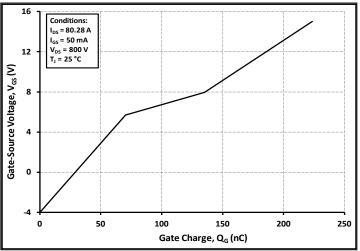
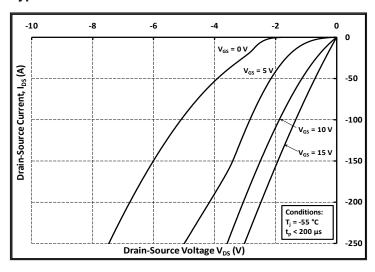


Figure 12. Gate Charge Characteristics



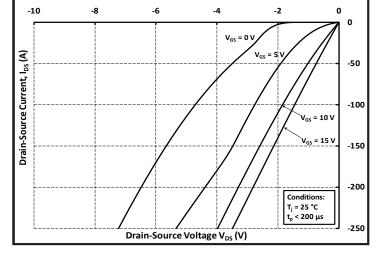
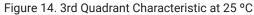
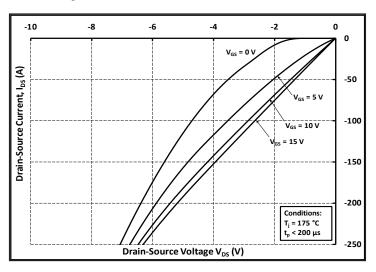


Figure 13. 3rd Quadrant Characteristic at -55 °C





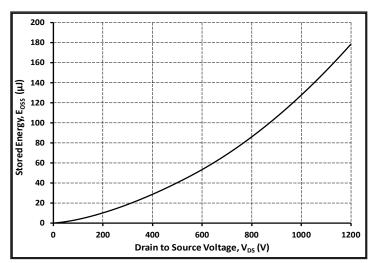
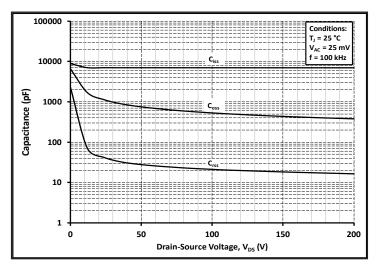


Figure 15. 3rd Quadrant Characteristic at 175 °C





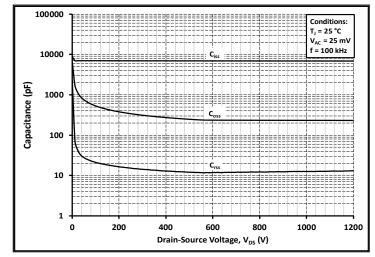
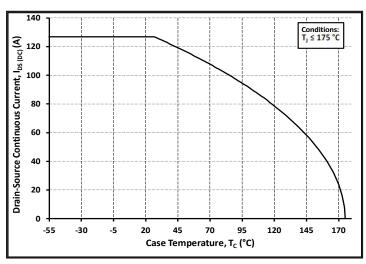


Figure 17. Capacitances vs. Drain-Source Voltage (0 - 200V)

Figure 18. Capacitances vs. Drain-Source Voltage (0 - 1200V)





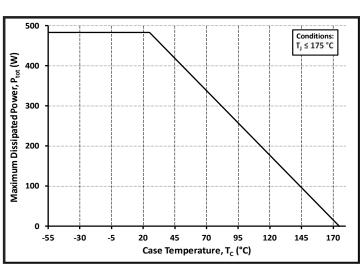


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

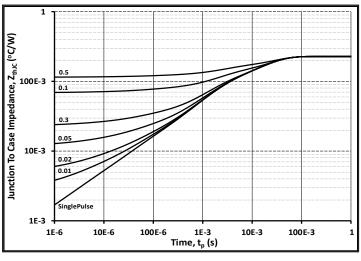


Figure 21. Transient Thermal Impedance (Junction - Case)

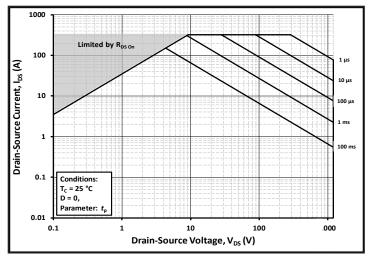


Figure 22. Safe Operating Area

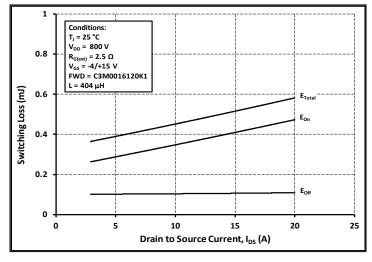


Figure 23. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 800V)

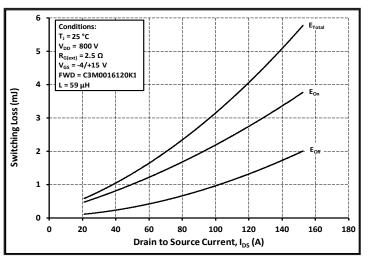


Figure 24. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 800V)

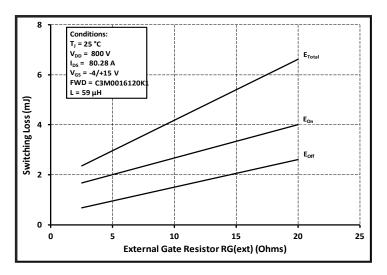


Figure 25. Clamped Inductive Switching Energy vs. $R_{\rm G(ext)}$

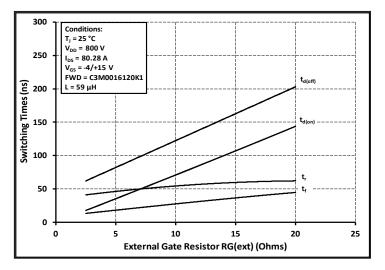


Figure 27. Switching Times vs. $R_{G(ext)}$

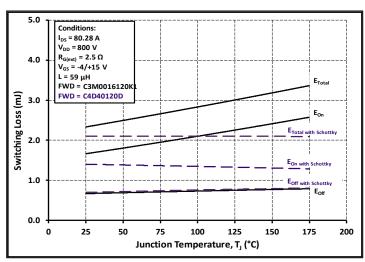


Figure 26. Clamped Inductive Switching Energy vs.
Temperature

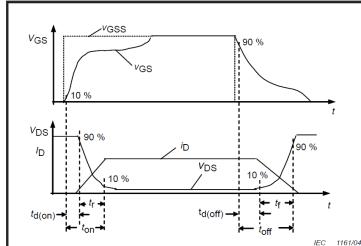


Figure 28. Switching Times Definition

9

Test Circuit Schematic

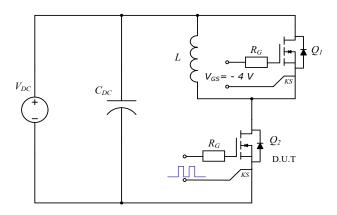
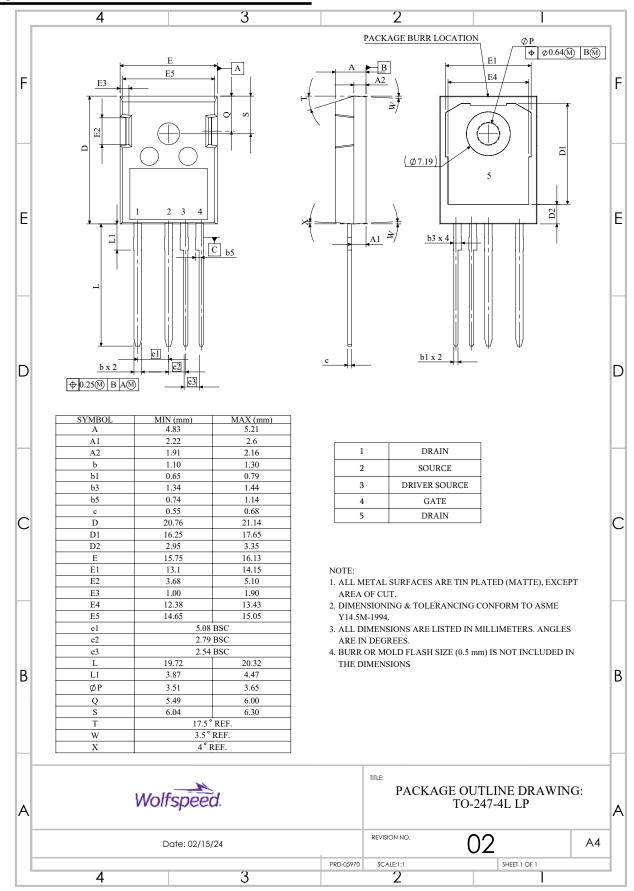


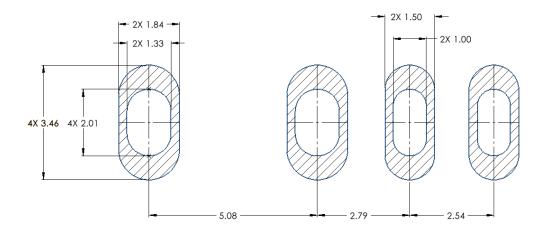
Figure 29. Clamped Inductive Switching Waveform Test Circuit

Package Dimensions



Recommended Solder Pad Layout

All dimensions in mm



Revision history

Document Version Date of release		Descriptiion of changes				
1.0	April-2024	Initial datasheet				

Notes & Disclaimer

This document and the information contained herein are subject to change without notice. Any such change shall be evidenced by the publication of an updated version of this document by Wolfspeed. No communication from any employee or agent of Wolfspeed or any third party shall effect an amendment or modification of this document. No responsibility is assumed by Wolfspeed for any infringement of patents or other rights of third parties which may result from use of the information contained herein. No license is granted by implication or otherwise under any patent or patent rights of Wolfspeed.

Notwithstanding any application-specific information, guidance, assistance, or support that Wolfspeed may provide, the buyer of this product is solely responsible for determining the suitability of this product for the buyer's purposes, including without limitation for use in the applications identified in the next bullet point, and for the compliance of the buyers' products, including those that incorporate this product, with all applicable legal, regulatory, and safety-related requirements.

This product has not been designed or tested for use in, and is not intended for use in, applications in which failure of the product would reasonably be expected to cause death, personal injury, or property damage, including but not limited to equipment implanted into the human body, life-support machines, cardiac defibrillators, and similar emergency medical equipment, aircraft navigation, communication, and control systems, aircraft power and propulsion systems, air traffic control systems, and equipment used in the planning, construction, maintenance, or operation of nuclear facilities.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Wolfspeed representative or from the Product Documentation sections of www.wolfspeed. com.

REACh Compliance

REACh substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact your Wolfspeed representative to ensure you get the most up-to-date REACh SVHC Declaration. REACh banned substance information (REACh Article 67) is also available upon request.

Contact info:

4600 Silicon Drive Durham, NC 27703 USA Tel: +1.919.313.5300 www.wolfspeed.com/power

© 2024 Wolfspeed, Inc. All rights reserved. Wolfspeed® and the Wolfstreak logo are registered trademarks and the Wolfspeed logo is a trademark of Wolfspeed, Inc. PATENT: https://www.wolfspeed.com/legal/patents

The information in this document is subject to change without notice.